Single Relay Driver IC

This ASIC provides up to 350 mA of drive current for driving a relay. On-chip diagnostic features include open and short circuit detection in the on state, duty cycle current limit control, and thermal shutdown. Faults are reported on the Fault lead. Fault is an active-low output. An on-chip zener provides protection from flyback pulses from the relay. Internal pull-down circuitry is provided to ensure the output pin turns off when the Control pin is floating.

Features

- Fault Detection
 - Open Circuit
 - Short Circuit
 - Overtemperature
- On-Chip Flyback Protection
- Low Standby Current
- Internally Fused Leads in SO-8 Package

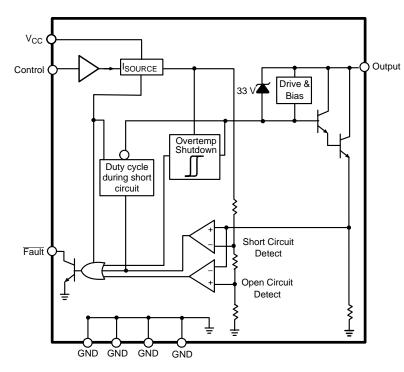


Figure 1. Block Diagram



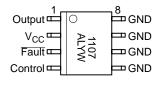
ON Semiconductor**

http://onsemi.com



SO-8 DF SUFFIX CASE 751

PIN CONNECTIONS AND MARKING DIAGRAM



А	= Assembly Location
WL, L	= Wafer Lot
ΥΥ, Υ	= Year
WW. W	= Work Week

ORDERING INFORMATION

Device	Package	Shipping
CS1107EDF8	SO–8	95 Units/Rail
CS1107EDFR8	SO–8	2500 Tape & Reel

MAXIMUM RATINGS*

Rating			Unit
Storage Temperature		-65 to +150	°C
V _{CC} , Fault, Control		-0.5 to 6.0	V
ESD Capability (Human Body Model)		2.0	kV
Peak Transient Voltage (output off mode, output pin only)	(26 V Load Dump @ 14 V V _{BAT})	40	V
Lead Temperature Soldering:	Reflow: (SMD styles only) (Note 1)	230 peak	°C
1. 60 second maximum above 183°C.		•	

*The maximum package power dissipation must be observed.

$\textbf{ELECTRICAL CHARACTERISTICS} \quad (4.75 \leq V_{CC} \leq 5.25 \text{ V}, -40^{\circ}\text{C} \leq \text{T}_{A} \\ \leq 85^{\circ}\text{C}, -40^{\circ}\text{C} \leq \text{T}_{J} \leq 150^{\circ}\text{C}; \text{ unless other-states}$

wise specified.)

Characteristic	Test Conditions	Min	Тур	Max	Unit
Supply Requirements	· ·				
V _{CC} Quiescent Current	Output ON	-	3.0	6.0	mA
V _{CC} Quiescent Current	Output OFF	-	70	250	μA
Output					
Leakage Current	V _{BAT} = 14 V	-	0	100	μΑ
Saturation Voltage	I _{OUTPUT} = 350 mA I _{OUTPUT} = 180 mA		1.1 0.9	1.5 1.3	V V
V _{CLAMP}	V _{CC} < 4.5 V, I _{OUTPUT} = 180 mA	29	33	36	V
Current Sense	· ·				
Short Circuit Current	-	350	500	650	mA
Open Circuit Current	Output in the ON state	20	40	60	mA
Control-Input					
Input Voltage	Logic = High Logic = Low	2.0		_ 0.8	V V
Input Current	Control = V _{CC}	_	40	80	μA
Fault Output – (Open Collector)	· · ·				
Output Low Voltage	I _{FAULT} = 250 μA (sink)	-	0.24	0.40	V
Overtemperature Shutdown					
T _J Output Disable Threshold	(Guaranteed by Design)	150	180	-	°C
T _J Hysteresis	(Guaranteed by Design)	5.0	-	-	°C

PACKAGE PIN DESCRIPTION

PACKAGE PIN #		
8 Lead SO Narrow	PIN SYMBOL	FUNCTION
1	Output	Open collector output.
2	V _{CC}	5.0 V regulated supply input.
3	Fault	Open collector diagnostic output low during open load, short circuit and overtemperature conditions.
4	Control	TTL compatible input. A high on this pin turns the output on.
5, 6, 7, 8	Ground	Signal ground.

CS1107

CIRCUIT DESCRIPTION

The CS1107 relay driver IC provides up to 350 mA of drive current in a low–side configuration. The Output driver pin is controlled through the TTL compatible Control input pin. A high condition on the Control pin turns the output pin on.

The Fault pin reports short circuit, open circuit, and overtemperature conditions on the IC. If a fault is present, the open collector output Fault pin will be low. Typical numbers for faults are: exceeding 500 mA of drive current will report a short circuit. Less than 40 mA (typical) will report an open circuit. A temperature fault will be reported when the die temperature exceeds 180°C (typical). Faults

are only reported when the Control pin is high, due to the low quiescent current when the Control pin is low and the output device is turned off.

Overcurrent protection is provided by duty cycle control. When the Output current exceeds the current limit threshold, the output enters duty cycle mode to reduce power dissipation of the IC to a safe level. The higher the threshold is exceeded the lower the duty cycle becomes.

A 33 V on–chip zener diode on the Output pin protects the device from flyback pulses when a relay is turned off. The saturation voltage of this pin will not exceed 1.5 V at 350 mA.

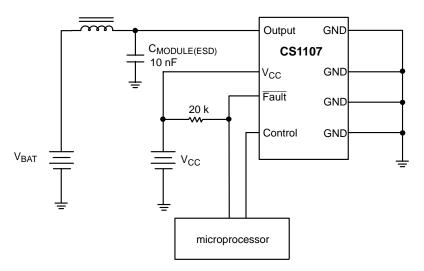
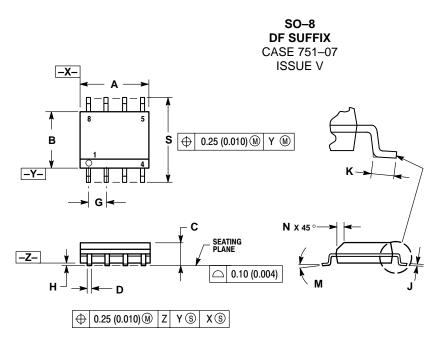


Figure 2. Applications Diagram

CS1107

PACKAGE DIMENSIONS



MILLIMETERS		INCHES	
MIN	MAX	MIN	MAX
4.80	5.00	0.189	0.197
3.80	4.00	0.150	0.157
1.35	1.75	0.053	0.069
0.33	0.51	0.013	0.020
1.27 BSC		0.050 BSC	
0.10	0.25	0.004	0.010
0.19	0.25	0.007	0.010
0.40	1.27	0.016	0.050
0 °	8 °	0 °	8 °
0.25	0.50	0.010	0.020
5.80	6.20	0.228	0.244
	MIN 4.80 3.80 1.35 0.33 1.27 0.10 0.19 0.40 0 ° 0.25	MIN MAX 4.80 5.00 3.80 4.00 1.35 1.75 0.33 0.51 1.27 BSC 0.10 0.19 0.25 0.40 1.27 0.61 0.25 0.40 1.27 0.51 0.51	$\begin{array}{ c c c c c c c c c c c c c c c c c c c$

PACKAGE THERMAL DATA

Parameter		SO–8	Unit
R _{ØJC}	Typical	25	°C/W
$R_{\Theta JA}$	Typical	110	°C/W

ON Semiconductor and without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer.

PUBLICATION ORDERING INFORMATION

Literature Fulfillment:

Literature Distribution Center for ON Semiconductor

P.O. Box 5163, Denver, Colorado 80217 USA

Phone: 303–675–2175 or 800–344–3860 Toll Free USA/Canada Fax: 303–675–2176 or 800–344–3867 Toll Free USA/Canada Email: ONlit@hibbertco.com

N. American Technical Support: 800-282-9855 Toll Free USA/Canada

JAPAN: ON Semiconductor, Japan Customer Focus Center 4–32–1 Nishi–Gotanda, Shinagawa–ku, Tokyo, Japan 141–0031 Phone: 81–3–5740–2700 Email: r14525@onsemi.com

ON Semiconductor Website: http://onsemi.com

For additional information, please contact your local Sales Representative.